

## Supporting Information

### **Changing molecular conjugation with phenazine acceptor for small molecule-based organic electronic memory performance**

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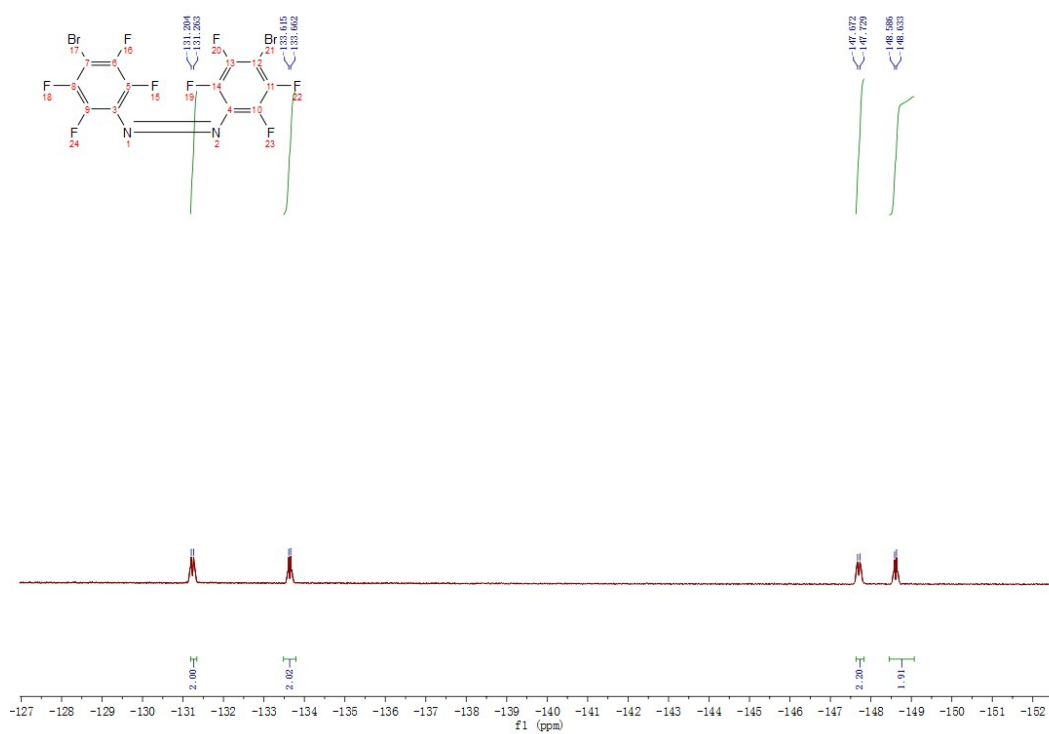
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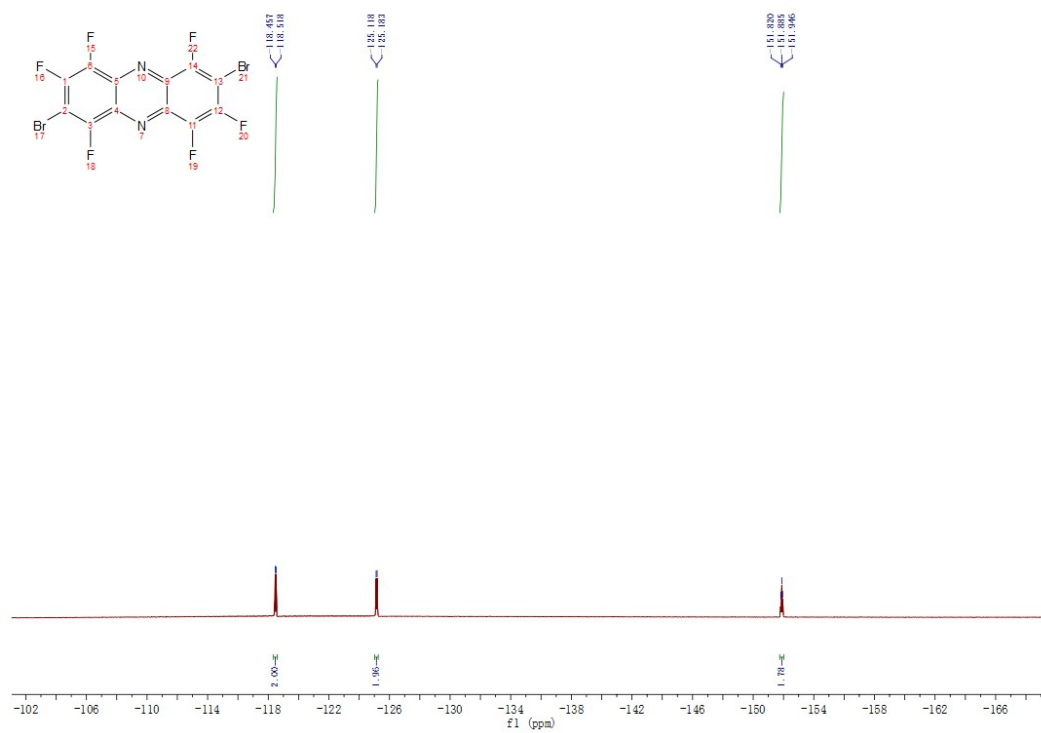
### *Contents*

<i>MS and NMR spectra of compounds .....</i>	<i>S2-S6</i>
<i>The I–V characteristics of the memory devices use LiF as block layer .....</i>	<i>S7</i>
<i>The long-term stability of the memory devices under ambient condition .....</i>	<i>S8</i>
<i>The memory behavior of the flexible memory devices under different bending conditions .....</i>	<i>S9</i>

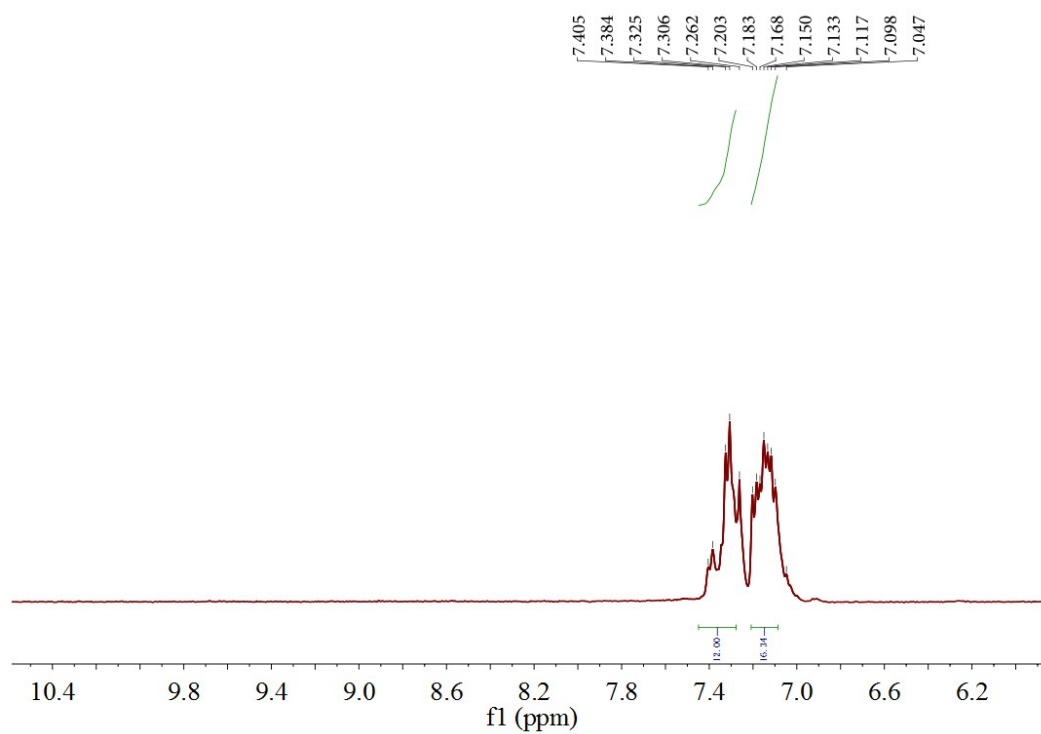
### $^{19}\text{F}$ NMR of compound 1



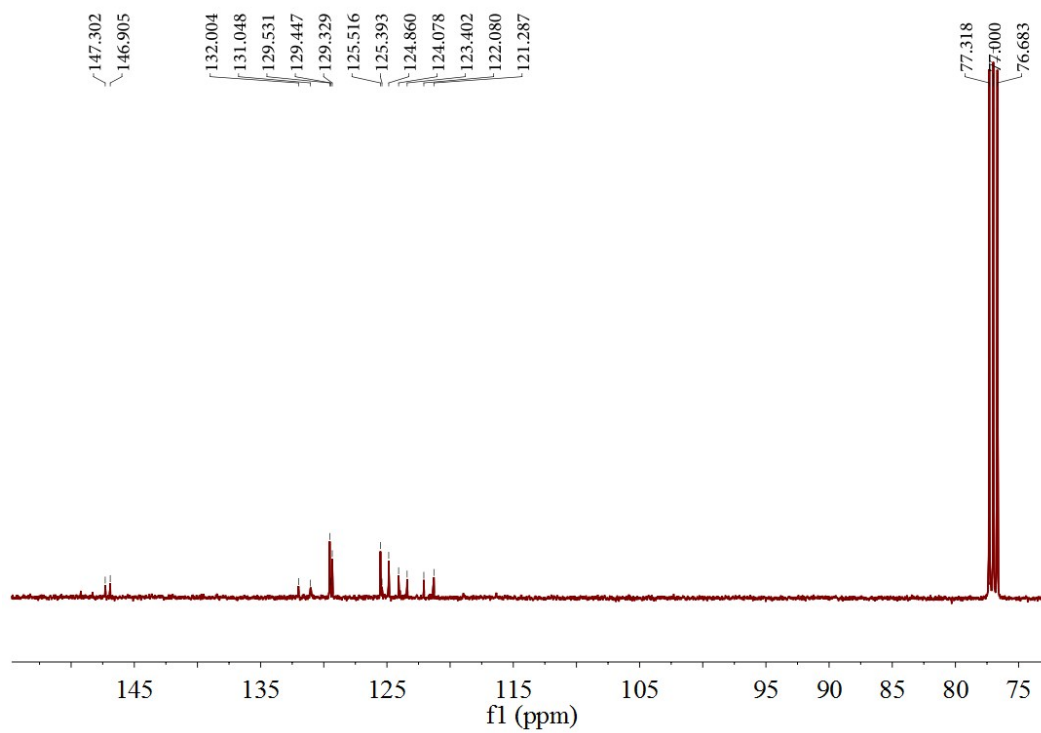
### $^{19}\text{F}$ NMR of compound 2



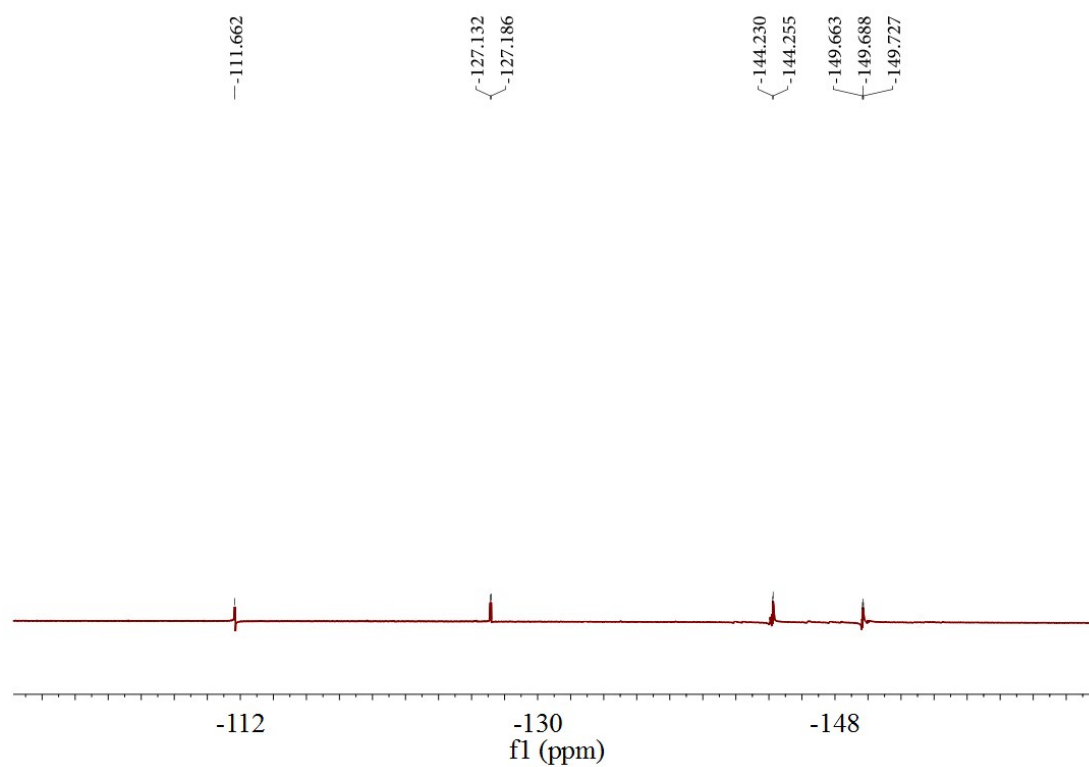
$^1\text{H}$  NMR of compound *TPA-azo-TPA*



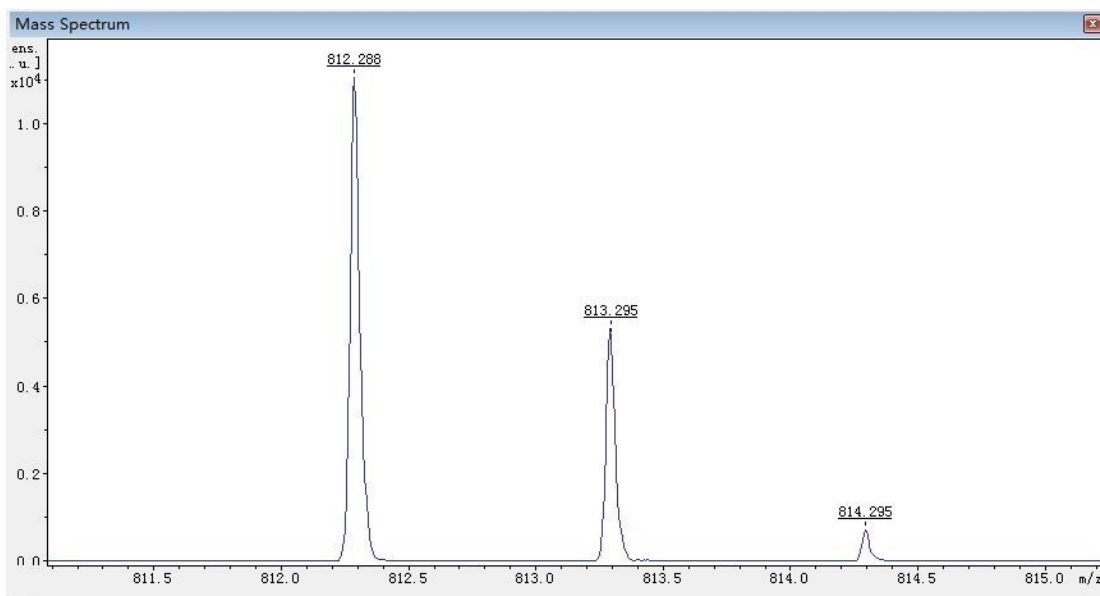
$^{13}\text{C}$  NMR of compound *TPA-azo-TPA*



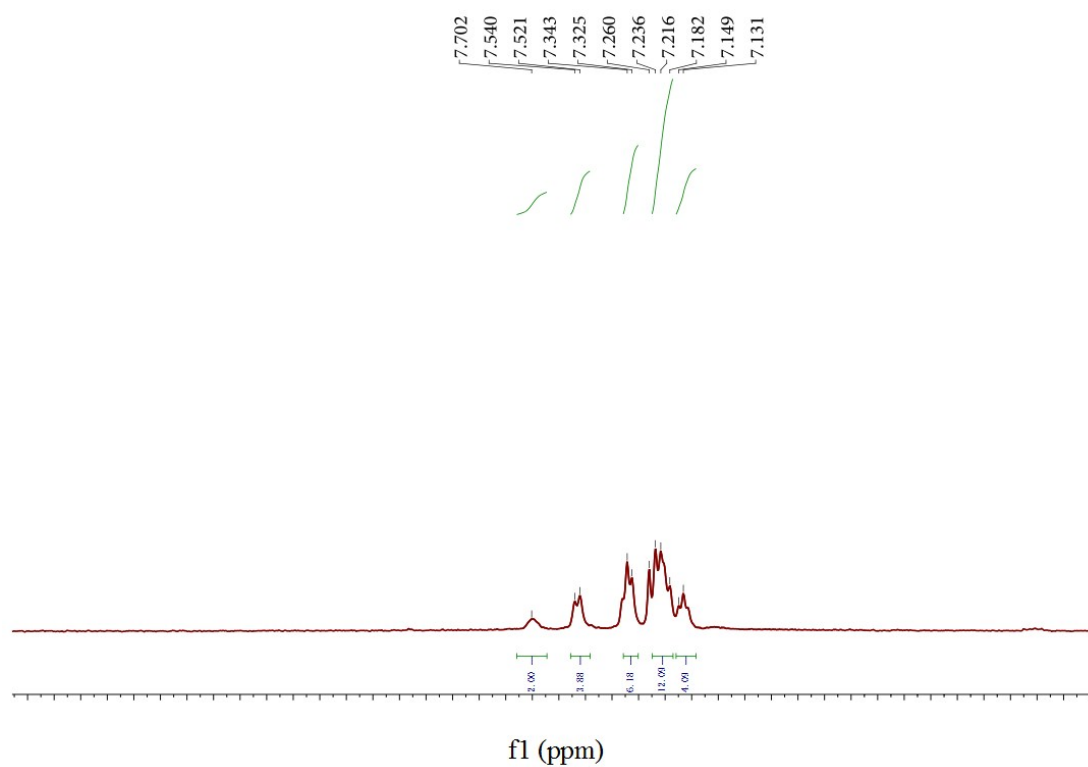
$^{19}\text{F}$  NMR of compound *TPA-azo-TPA*



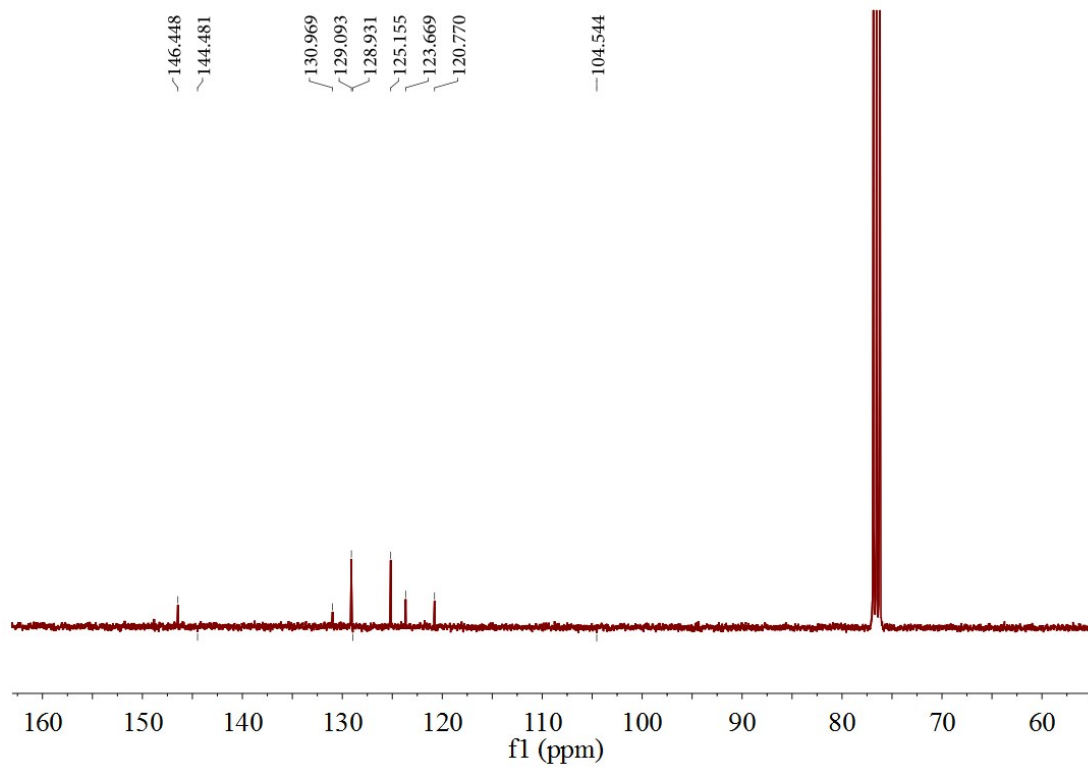
MS of compound *TPA-azo-TPA*



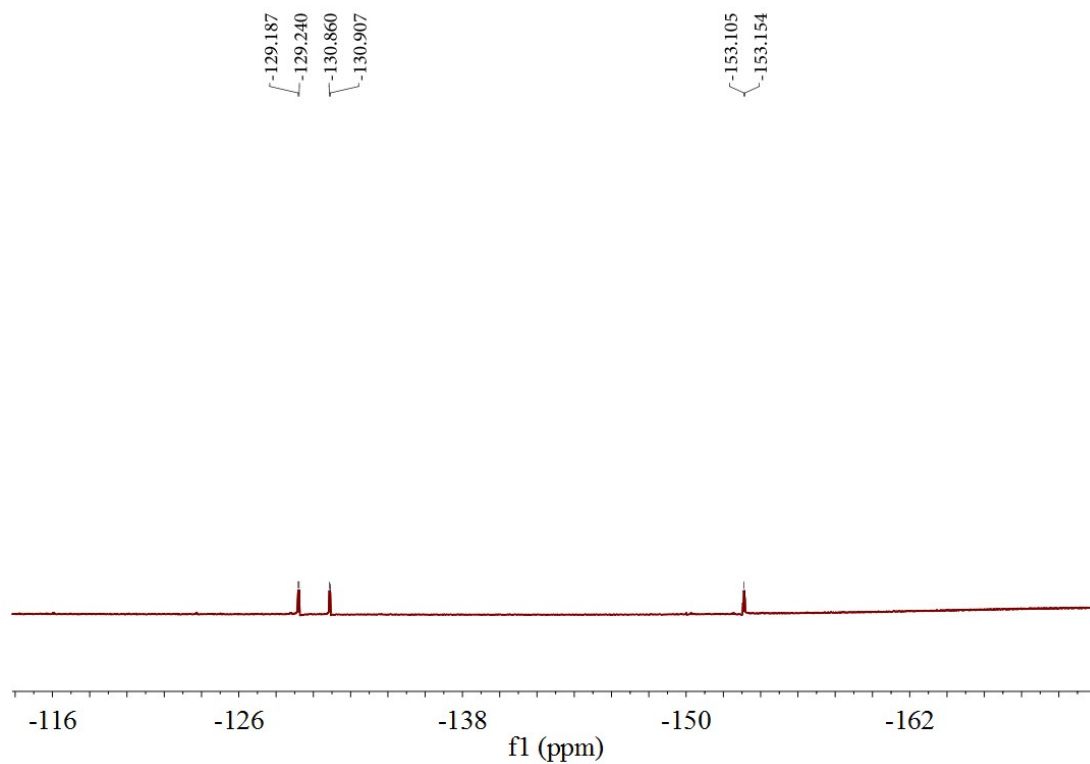
$^1\text{H}$  NMR of compound *TPA-ph-TPA*



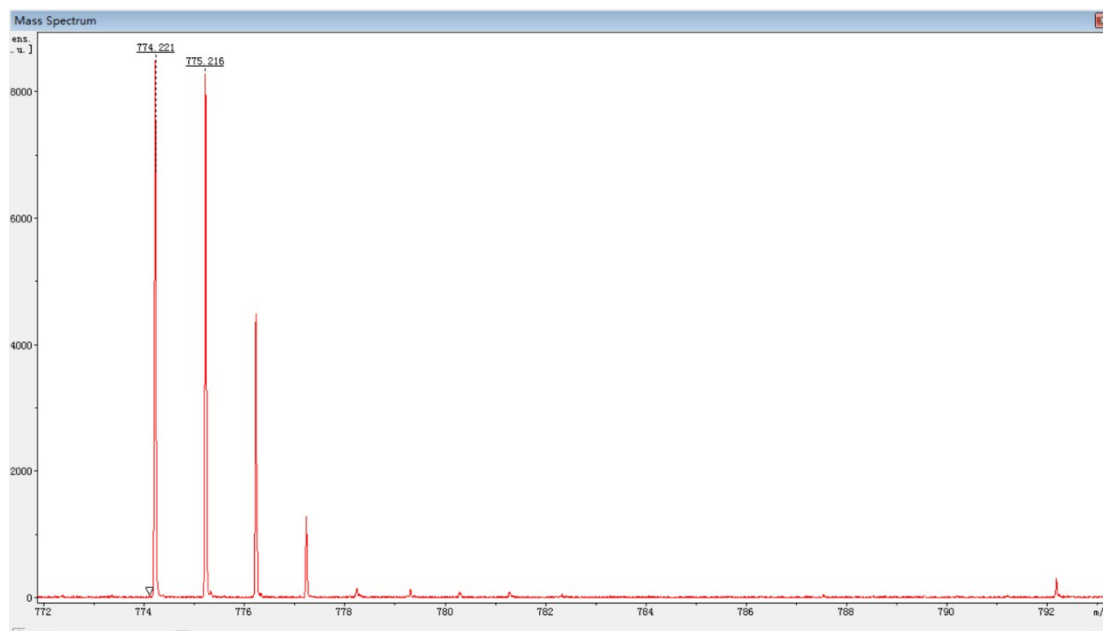
$^{13}\text{C}$  NMR of compound *TPA-ph-TPA*

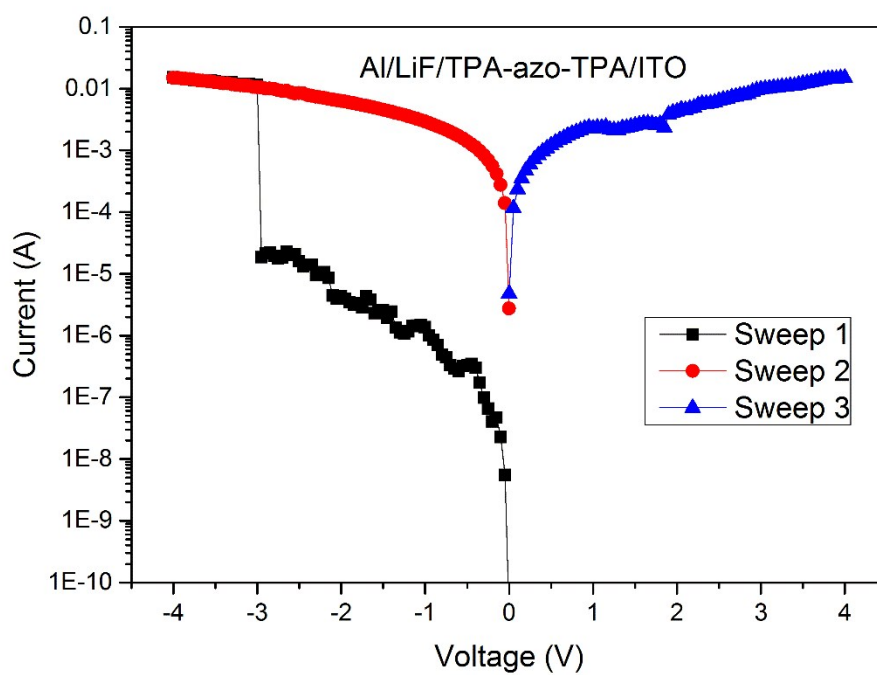


$^{19}\text{F}$  NMR of compound *TPA-ph-TPA*

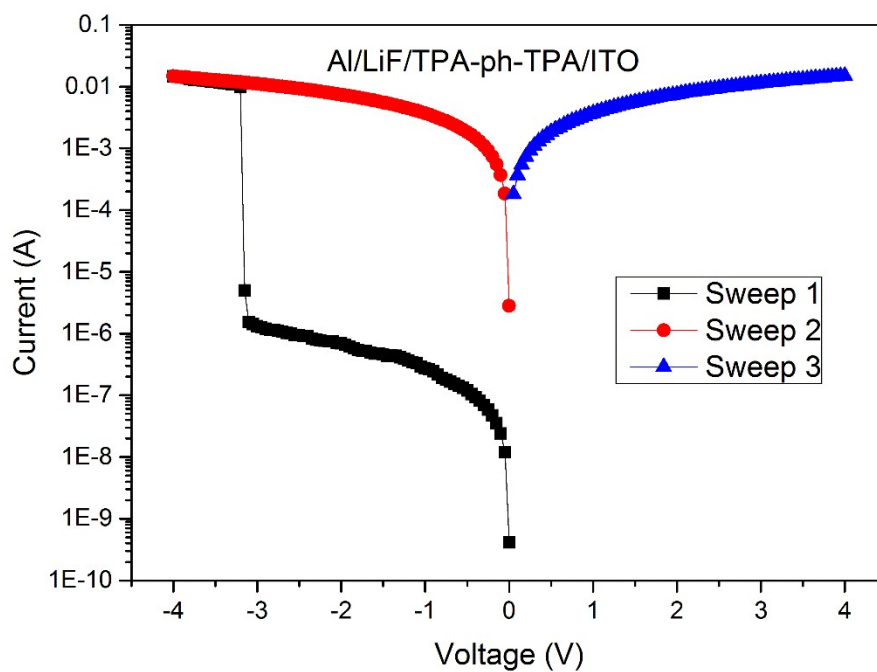


MS of compound *TPA-ph-TPA*

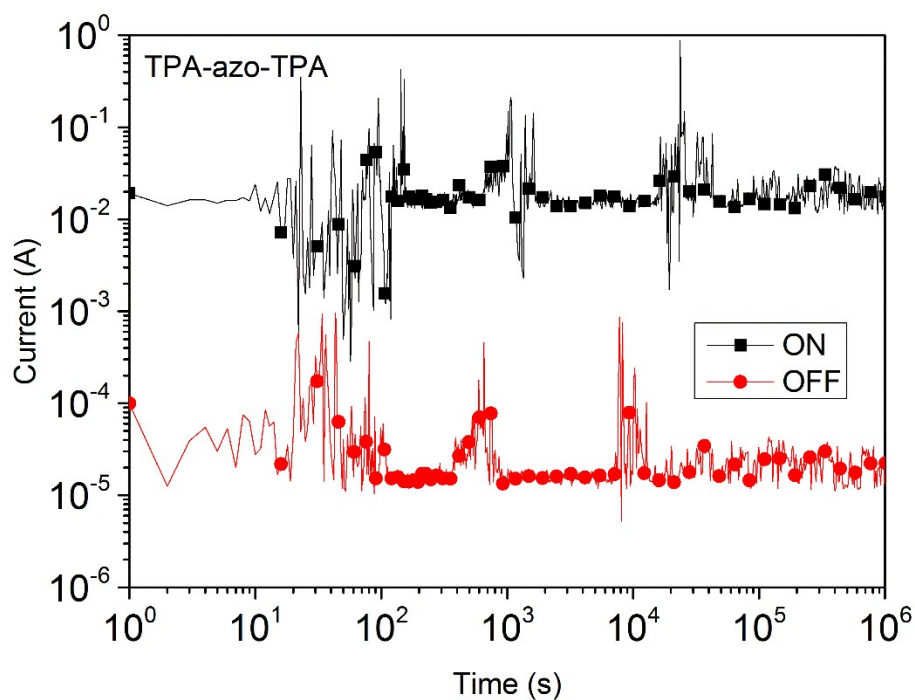




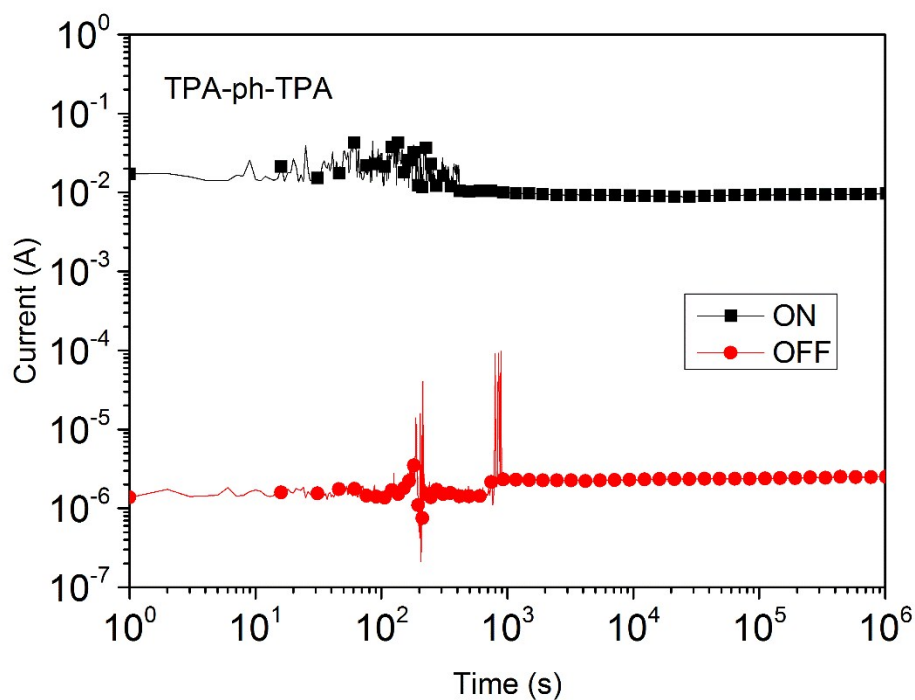
**Figure S1** I-V characteristics of Al /LiF (5 nm)/ TPA-azo-TPA / ITO memory devices.



**Figure S2** I-V characteristics of Al /LiF (5 nm)/ TPA-ph-TPA / ITO memory devices.

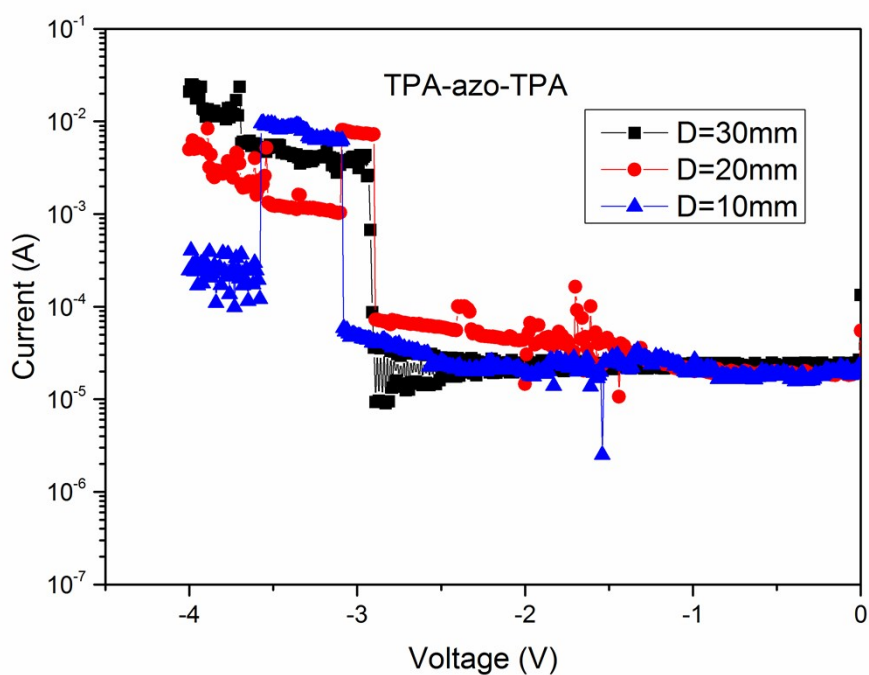


**Figure S3** The effect of retention time of Al/ TPA-azo-TPA /ITO-based memory device under a constant stress of -1.0 V in air and humidity condition.

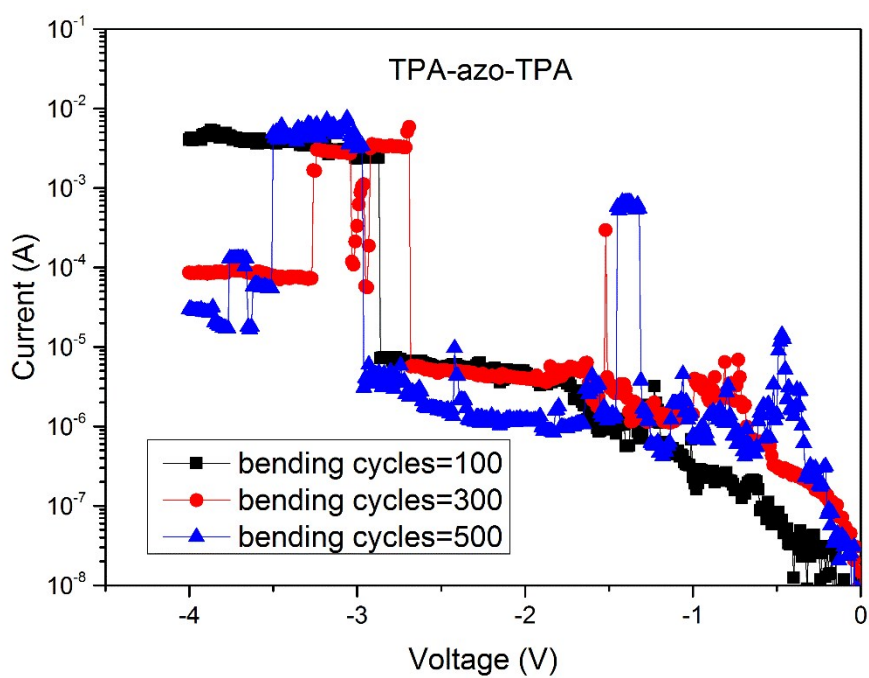


**Figure S4** The effect of retention time of Al/ TPA-ph-TPA /ITO-based memory device under a constant stress of -1.0 V in air and humidity condition.





**Figure S5** The memory effects of the Al/ TPA-azo-TPA /Al-based flexible memory devices in different bending degrees. the distance between the end of the arc define as (D).



**Figure S6** The memory effects of the Al/ TPA-azo-TPA /Al-based flexible memory devices under different bending cycles in the maximum bending condition.